

## N-Ch 40V Fast Switching MOSFETs

### Features

- Advanced Trench MOS Technology
- 100% EAS Guaranteed
- High Current Capability
- Green Device Available

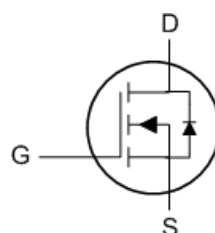
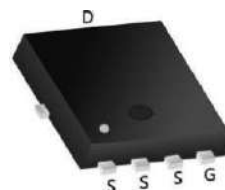
### Applications

- SMPS Synchronous Rectification
- DC/DC Converters
- Or-ing

### Product Summary

| BVDSS | RDSON | ID   |
|-------|-------|------|
| 40V   | 1.1mΩ | 255A |

### PRPAK5X6 Pin Configuration



### Absolute Maximum Ratings

| Symbol                          | Parameter                                      | Rating     | Units            |
|---------------------------------|------------------------------------------------|------------|------------------|
| $V_{DS}$                        | Drain-Source Voltage                           | 40         | V                |
| $V_{GS}$                        | Gate-Source Voltage                            | $\pm 20$   | V                |
| $I_D @ T_C = 25^\circ\text{C}$  | Continuous Drain Current, $V_{GS} @ 10V^{1,6}$ | 255        | A                |
| $I_D @ T_C = 100^\circ\text{C}$ | Continuous Drain Current, $V_{GS} @ 10V^{1,6}$ | 180        | A                |
| $I_D @ T_A = 25^\circ\text{C}$  | Continuous Drain Current, $V_{GS} @ 10V^1$     | 37         | A                |
| $I_D @ T_A = 70^\circ\text{C}$  | Continuous Drain Current, $V_{GS} @ 10V^1$     | 31         | A                |
| $I_{DM}$                        | Pulsed Drain Current <sup>2</sup>              | 400        | A                |
| EAS                             | Single Pulse Avalanche Energy <sup>3</sup>     | 245        | mJ               |
| $I_{AS}$                        | Avalanche Current                              | 70         | A                |
| $P_D @ T_C = 25^\circ\text{C}$  | Total Power Dissipation <sup>4</sup>           | 107        | W                |
| $P_D @ T_A = 25^\circ\text{C}$  | Total Power Dissipation <sup>4</sup>           | 2.4        | W                |
| $T_{STG}$                       | Storage Temperature Range                      | -55 to 175 | $^\circ\text{C}$ |
| $T_J$                           | Operating Junction Temperature Range           | -55 to 175 | $^\circ\text{C}$ |

### Thermal Data

| Symbol          | Parameter                                        | Typ. | Max. | Unit               |
|-----------------|--------------------------------------------------|------|------|--------------------|
| $R_{\theta JA}$ | Thermal Resistance Junction-Ambient <sup>1</sup> | ---  | 62   | $^\circ\text{C/W}$ |
| $R_{\theta JC}$ | Thermal Resistance Junction-Case <sup>1</sup>    | ---  | 1.4  | $^\circ\text{C/W}$ |

**Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)**

| Symbol       | Parameter                                      | Conditions                                                   | Min. | Typ. | Max.      | Unit       |
|--------------|------------------------------------------------|--------------------------------------------------------------|------|------|-----------|------------|
| $BV_{DSS}$   | Drain-Source Breakdown Voltage                 | $V_{GS}=0V$ , $I_D=250\mu A$                                 | 40   | ---  | ---       | V          |
| $R_{DS(ON)}$ | Static Drain-Source On-Resistance <sup>2</sup> | $V_{GS}=10V$ , $I_D=20A$                                     | ---  | 0.9  | 1.1       | m $\Omega$ |
| $V_{GS(th)}$ | Gate Threshold Voltage                         | $V_{GS}=V_{DS}$ , $I_D=250\mu A$                             | 2    | 2.8  | 4         | V          |
| $I_{DSS}$    | Drain-Source Leakage Current                   | $V_{DS}=32V$ , $V_{GS}=0V$ , $T_J=25^\circ\text{C}$          | ---  | ---  | 1         | $\mu A$    |
|              |                                                | $V_{DS}=32V$ , $V_{GS}=0V$ , $T_J=55^\circ\text{C}$          | ---  | ---  | 5         |            |
| $I_{GSS}$    | Gate-Source Leakage Current                    | $V_{GS}=\pm 20V$ , $V_{DS}=0V$                               | ---  | ---  | $\pm 100$ | nA         |
| $R_g$        | Gate Resistance                                | $V_{DS}=0V$ , $V_{GS}=0V$ , $f=1\text{MHz}$                  | ---  | 1.2  | ---       | $\Omega$   |
| $Q_g$        | Total Gate Charge                              | $V_{DS}=20V$ , $V_{GS}=10V$ , $I_D=20A$                      | ---  | 108  | ---       | nC         |
| $Q_{gs}$     | Gate-Source Charge                             |                                                              | ---  | 25.4 | ---       |            |
| $Q_{gd}$     | Gate-Drain Charge                              |                                                              | ---  | 26.8 | ---       |            |
| $T_{d(on)}$  | Turn-On Delay Time                             | $V_{DD}=20V$ , $V_{GS}=10V$ , $R_G=1.5\Omega$ ,<br>$I_D=20A$ | ---  | 20   | ---       | ns         |
| $T_r$        | Rise Time                                      |                                                              | ---  | 145  | ---       |            |
| $T_{d(off)}$ | Turn-Off Delay Time                            |                                                              | ---  | 55   | ---       |            |
| $T_f$        | Fall Time                                      |                                                              | ---  | 18   | ---       |            |
| $C_{iss}$    | Input Capacitance                              | $V_{DS}=20V$ , $V_{GS}=0V$ , $f=1\text{MHz}$                 | ---  | 6601 | ---       | pF         |
| $C_{oss}$    | Output Capacitance                             |                                                              | ---  | 2073 | ---       |            |
| $C_{rss}$    | Reverse Transfer Capacitance                   |                                                              | ---  | 248  | ---       |            |

**Diode Characteristics**

| Symbol   | Parameter                                | Conditions                                      | Min. | Typ. | Max. | Unit |
|----------|------------------------------------------|-------------------------------------------------|------|------|------|------|
| $I_S$    | Continuous Source Current <sup>1,6</sup> | $V_G=V_D=0V$ , Force Current                    | ---  | ---  | 100  | A    |
| $V_{SD}$ | Diode Forward Voltage <sup>2</sup>       | $V_{GS}=0V$ , $I_S=1A$ , $T_J=25^\circ\text{C}$ | ---  | ---  | 1.2  | V    |

Note :

1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
2. The data tested by pulsed, pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$
3. The EAS data shows Max. rating. The test condition is  $V_{DD}=25V$ ,  $V_{GS}=10V$ ,  $L=0.1mH$ ,  $I_{AS}=70A$
4. The power dissipation is limited by  $150^\circ\text{C}$  junction temperature
5. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.
6. Package limitation current is 100A.

## Typical Characteristics

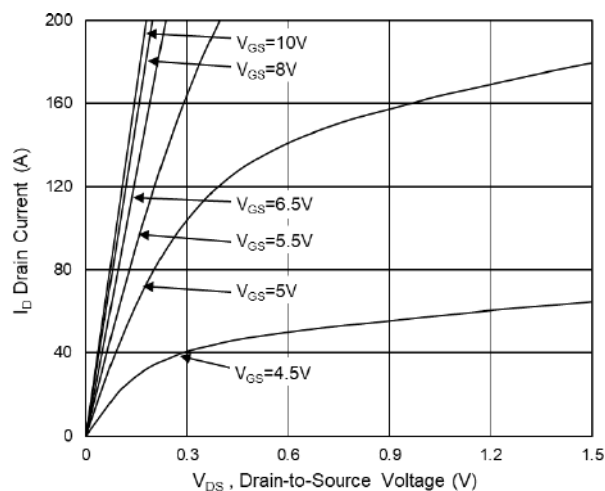


Fig.1 Typical Output Characteristics

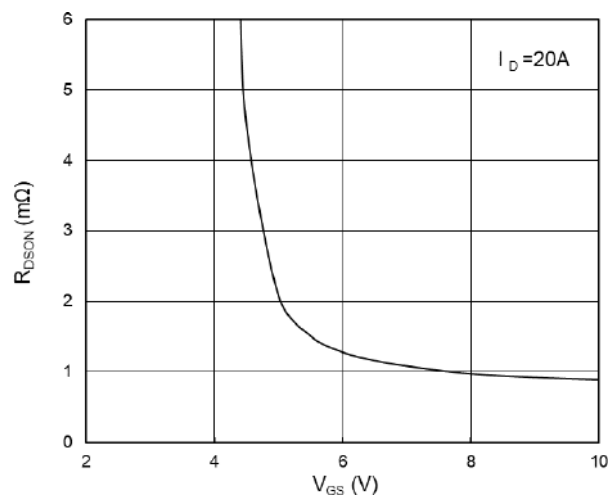


Fig.2 On-Resistance vs G-S Voltage

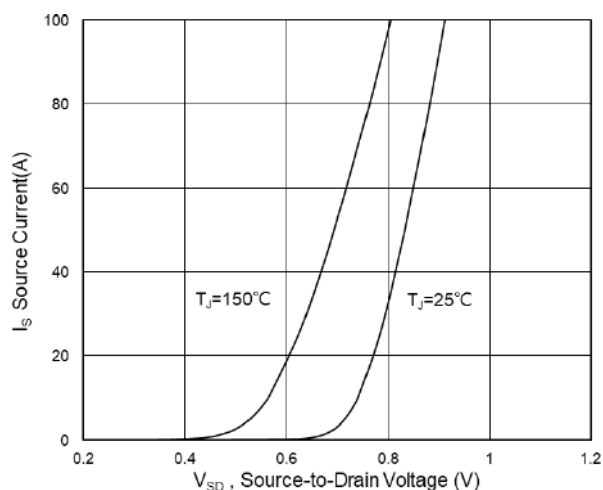


Fig.3 Source Drain Forward Characteristics

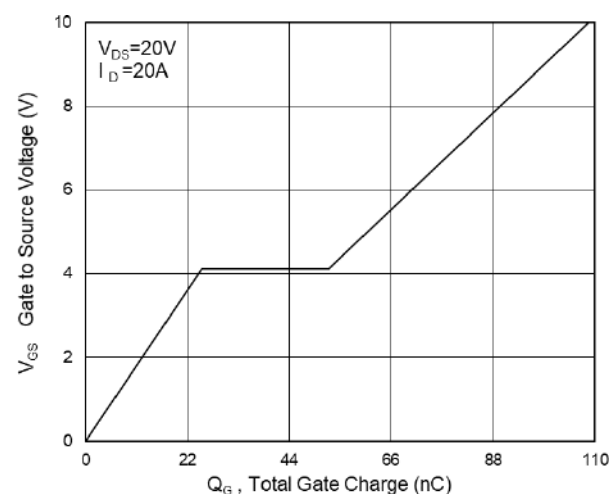


Fig.4 Gate-Charge Characteristics

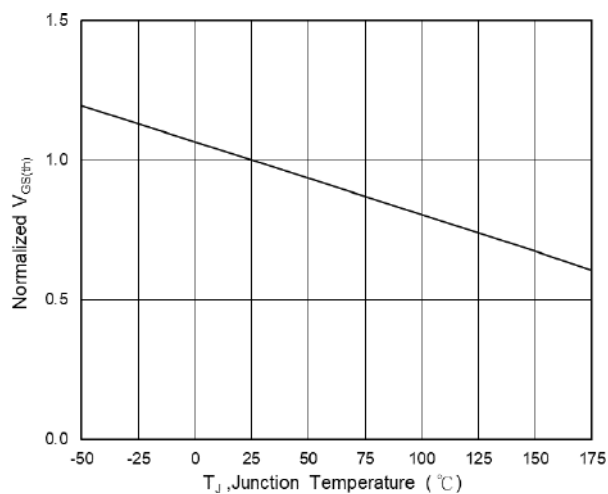


Fig.5 Normalized  $V_{GS(th)}$  vs  $T_J$

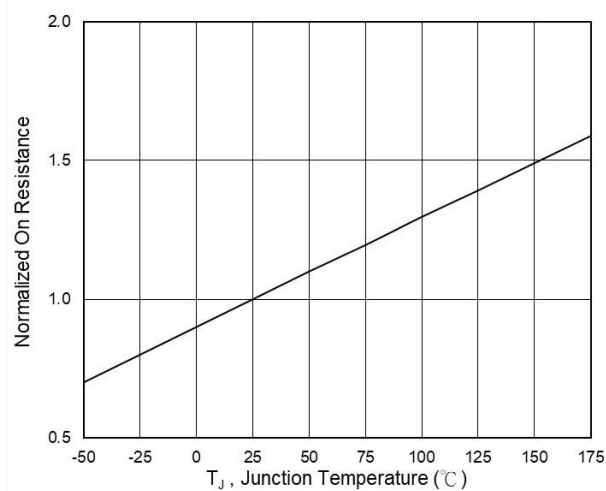
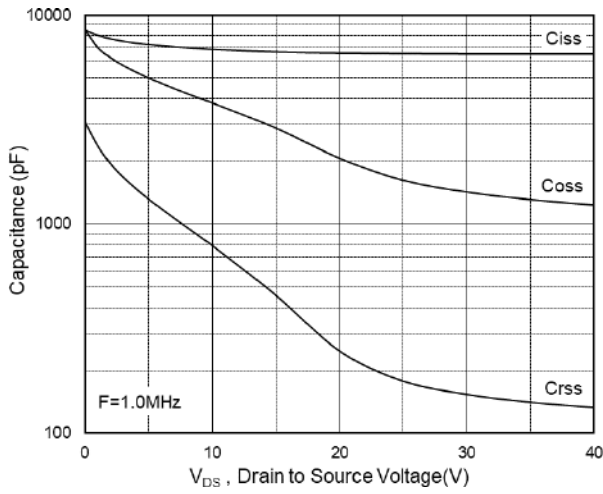
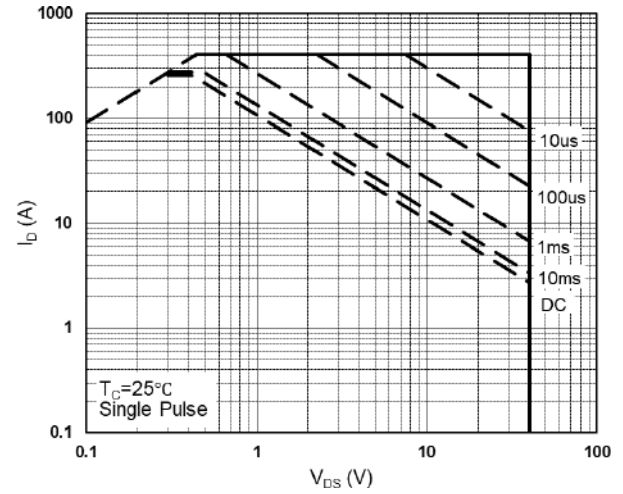


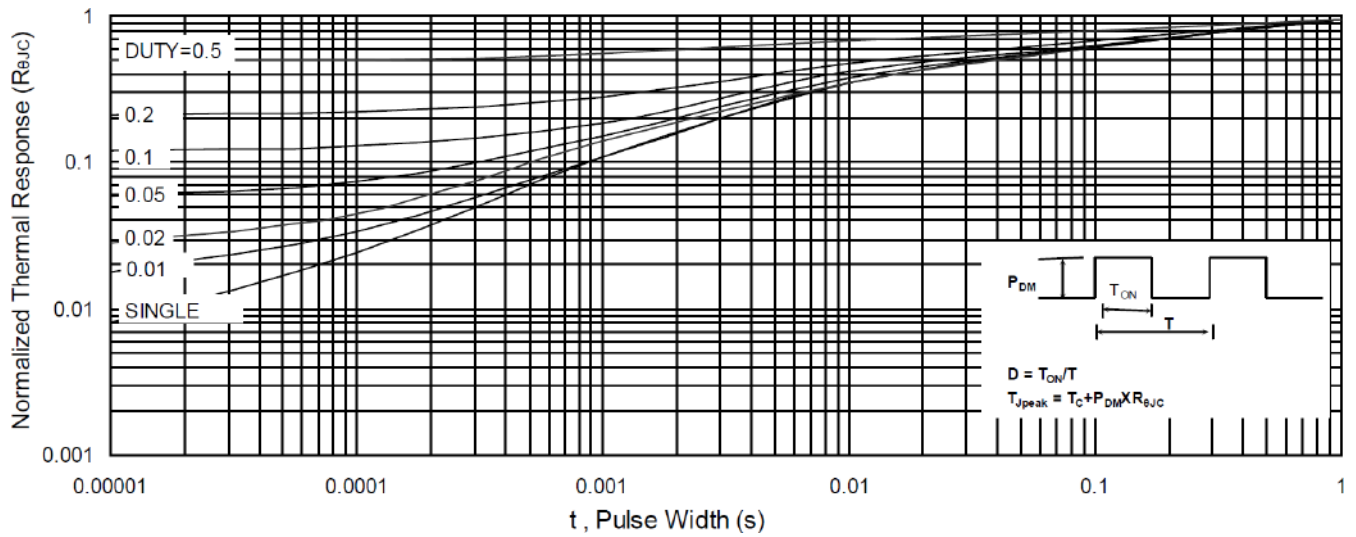
Fig.6 Normalized  $R_{DS(on)}$  vs  $T_J$



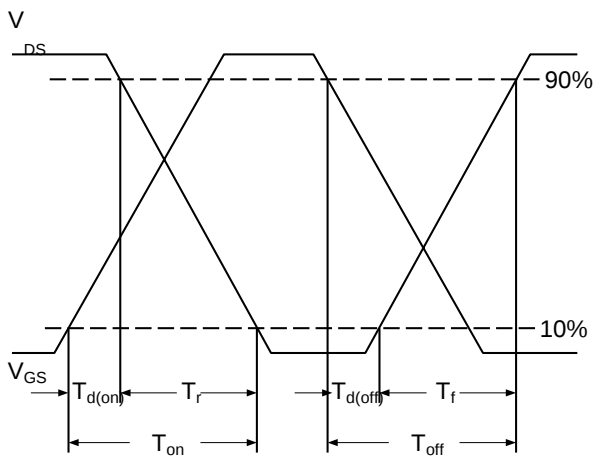
**Fig.7 Capacitance**



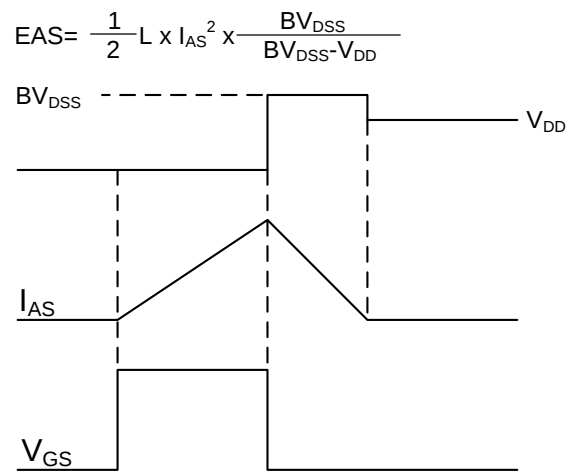
**Fig.8 Safe Operating Area**



**Fig.9 Normalized Maximum Transient Thermal Impedance**



**Fig.10 Switching Time Waveform**



**Fig.11 Unclamped Inductive Switching Waveform**